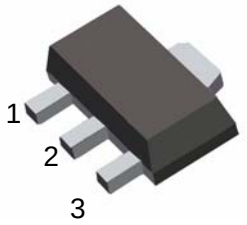
WG6003

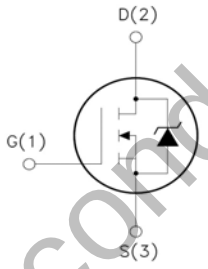
Features:

- ☐ Low Intrinsic Capacitances.
- ☐ Excellent Switching Characteristics.
- ☐ Extended Safe Operating Area.
- ☐ Unrivalled Gate Charge :Qg=14.6nC (Typ.).
- ☐ BVDSS=60V,I_D=3A
- ☐ $R_{DS(on)}$:100mΩ (Max) @V_G=10V
- ☐ 100% Avalanche Tested

SOT-89

RoHS COMPLIANT





1.Gate (G)
2.Drain (D)
3.Source (S)

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Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	3	A
Drain Current-Pulsed (Note 1)	I_{DM}	10	A
Maximum Power Dissipation	P_D	1.7	W
Single pulse avalanche energy (Note 5)	E_{AS}	16.2	mJ
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 To 150	℃

Thermal Characteristic

Thermal Resistance,Junction-to-Case (Note 2)	$R_{\theta JC}$	10	℃/W
Thermal Resistance,Junction-to-Ambient (Note 2)	$R_{\theta JA}$	73.5	℃/W

Electrical Characteristics (T_A=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=250μA	60	65	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=60V,V_{GS}=0V	-	-	1	μA
Parameter	**Symbol**	**Condition**	**Min**	**Typ**	**Max**	**Unit**
Gate-Body Leakage Current	I_{GSS}	V_{GS}=±20V,V_{DS}=0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250μA	1.0	1.3	2.0	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=3A	-	73	100	mΩ
		V_{GS}=4.5V, I_D=3A	-	90	120	mΩ
Forward Transconductance	g_{FS}	V_{DS}=5V,I_D=3A	4	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C_{lss}	V_{DS}=30V,V_{GS}=0V, F=1.0MHz	-	510	-	PF
Output Capacitance	C_{oss}		-	34	-	PF
Reverse Transfer Capacitance	C_{rss}		-	26	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=30V,I_D=3A V_{GS}=10V,R_{GEN}=1Ω	-	6	-	nS
Turn-on Rise Time	t_r		-	15	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	15	-	nS
Turn-Off Fall Time	t_f		-	10	-	nS
Total Gate Charge	Q_g	V_{DS}=30V,I_D=3A, V_{GS}=10V	-	14.6	-	nC
Gate-Source Charge	Q_{gs}		-	1.6	-	nC
Gate-Drain Charge	Q_{gd}		-	3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS}=0V,I_S=3A	-	-	1.2	V
Diode Forward Current (Note 2)	I_S		-	-	3	A

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5.EAS condition : Tj=25℃,V_{DD}=-30V,V_G=-10V,L=0.5mH,Rg=25Ω

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Typical Electrical and Thermal Characteristics (Curves)

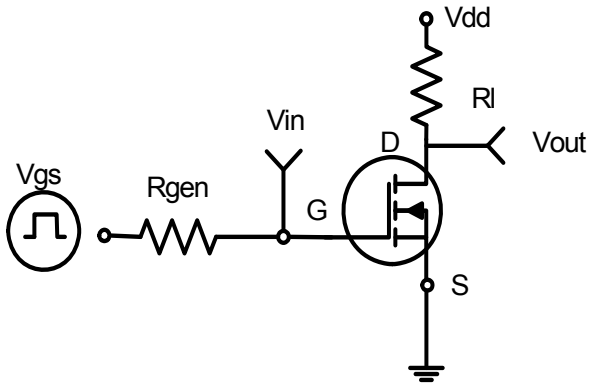

Figure 1 Switching Test Circuit

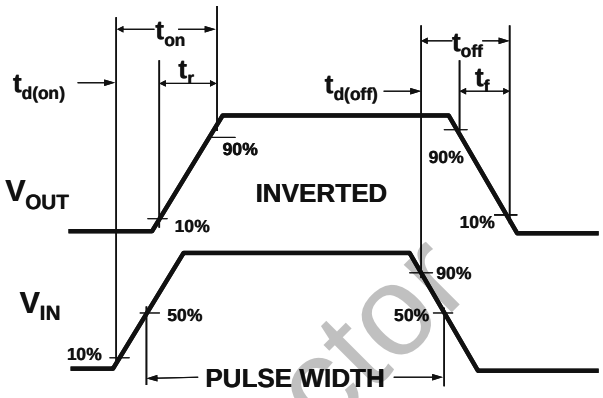

Figure 2 Switching Waveforms

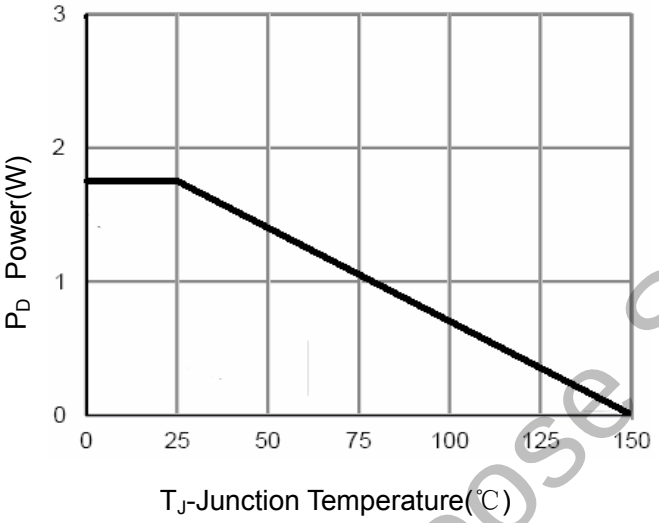

Figure 3 Power Dissipation

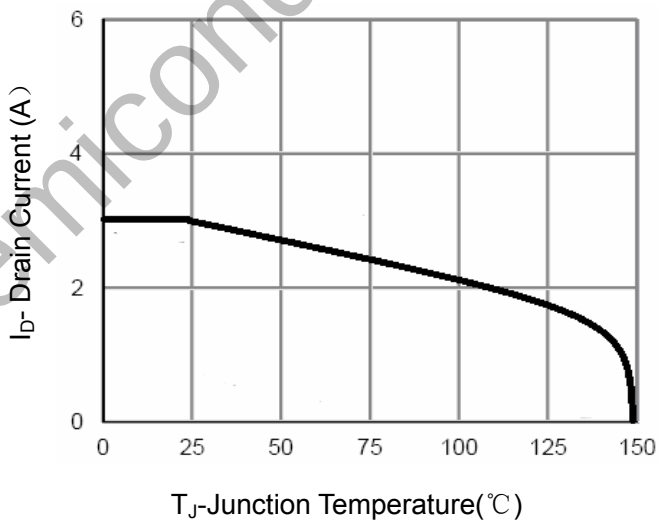

Figure 4 Drain Current

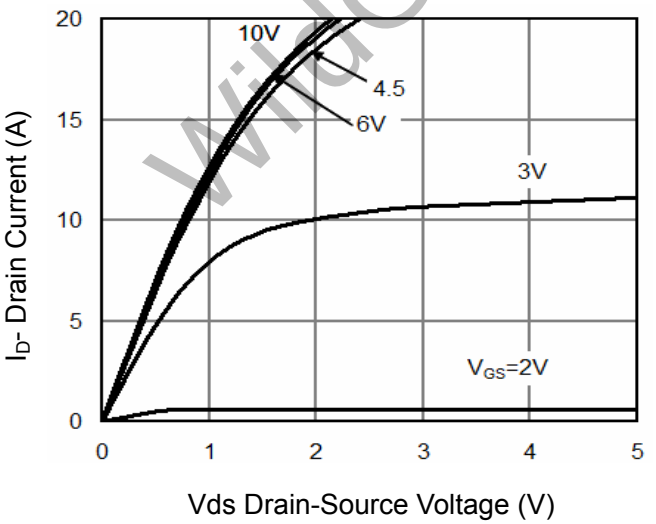

Figure 5 Output Characteristics

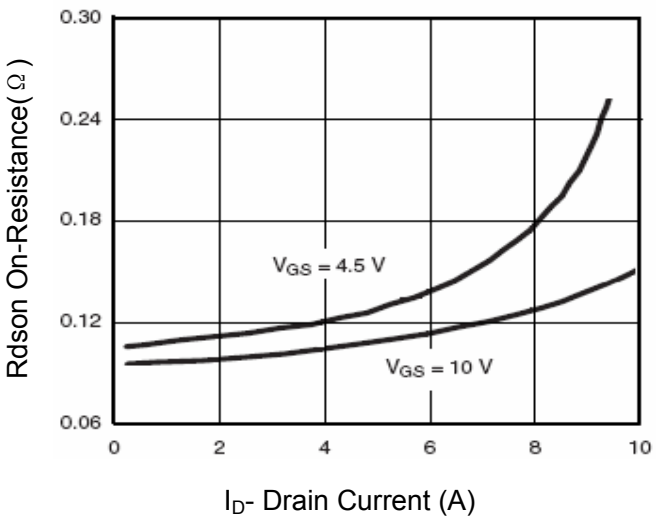

Figure 6 Drain-Source On-Resistance

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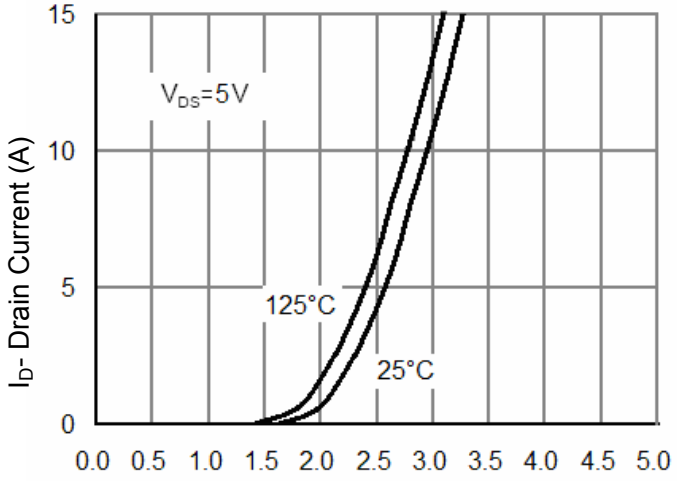

Figure 7 Transfer Characteristics

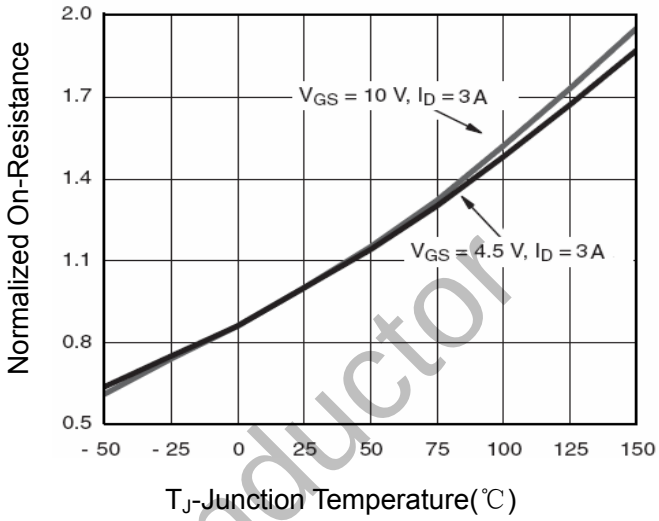

Figure 8 Drain-Source On-Resistance

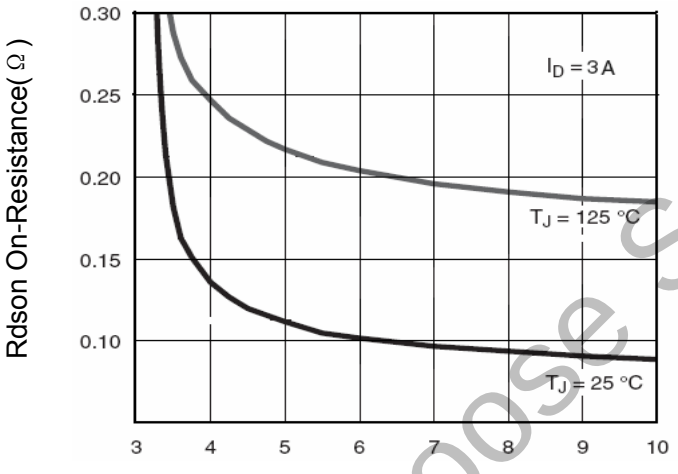

Figure 9 Rdson vs Vgs

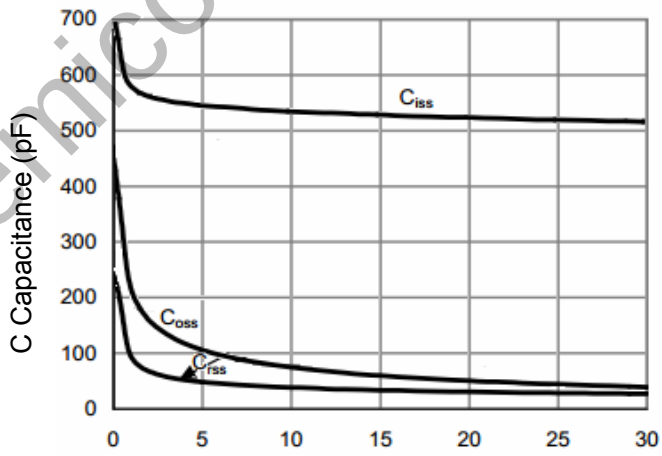

Figure 10 Capacitance vs Vds

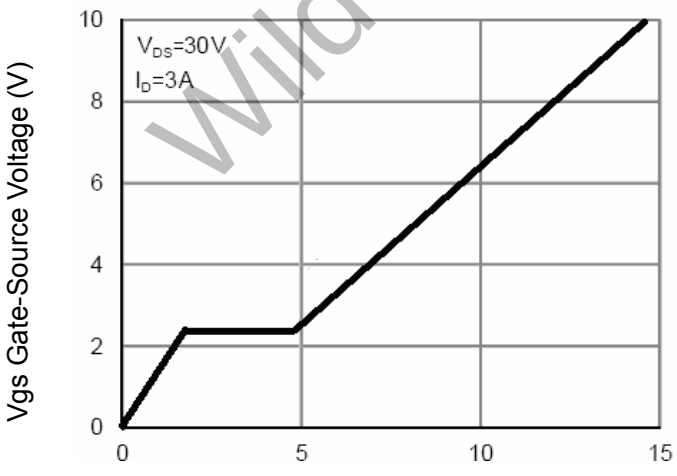

Figure 11 Gate Charge

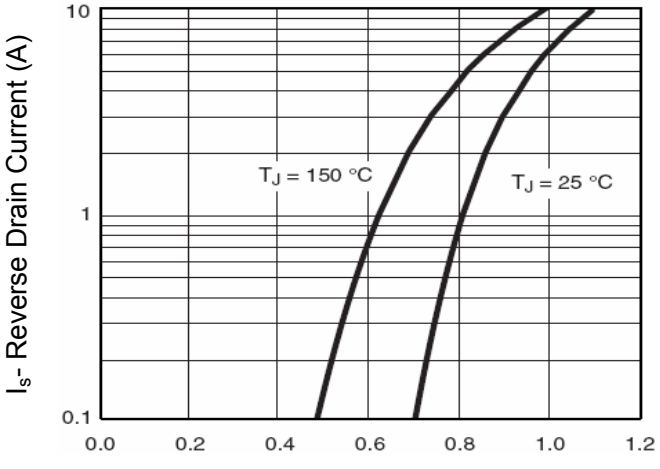

Figure 12 Source- Drain Diode Forward

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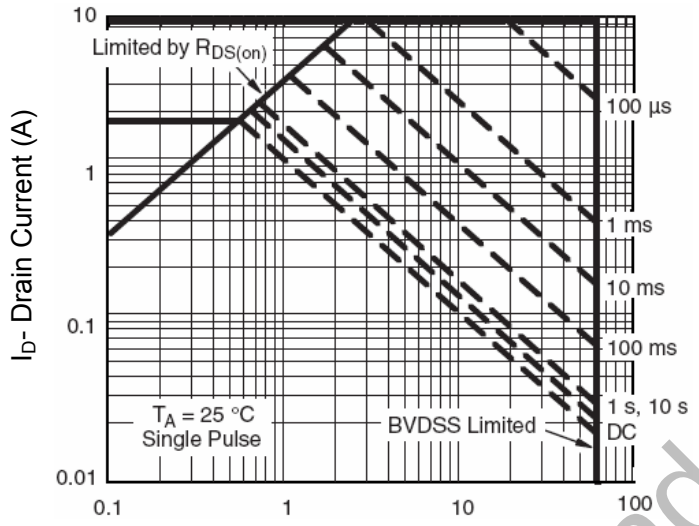

Figure 13 Safe Operation Area

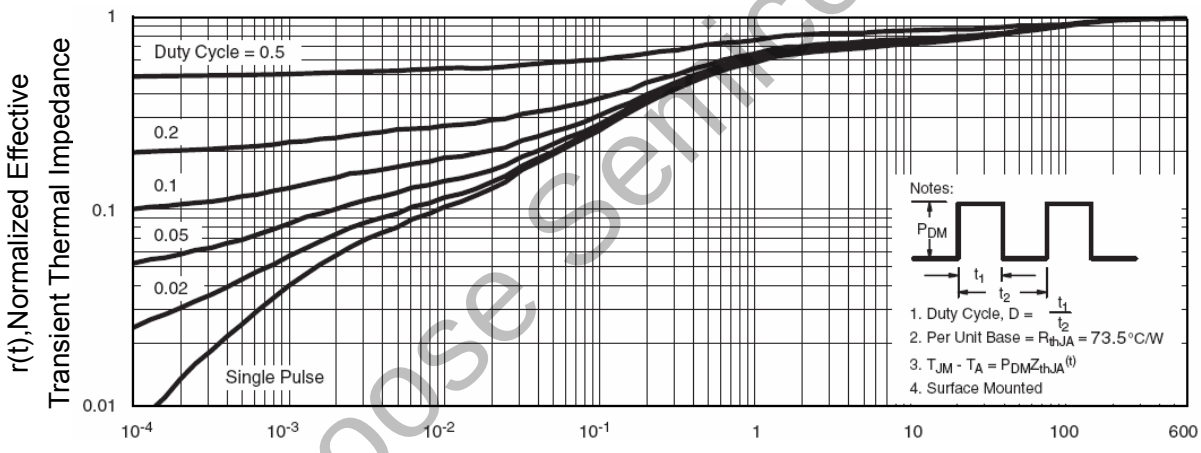

Figure 14 Normalized Maximum Transient Thermal Impedance

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Package Dimension

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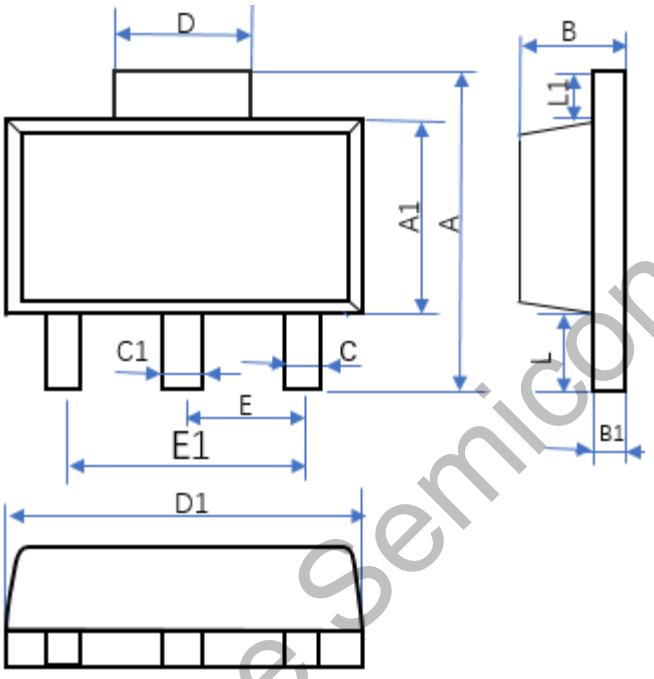

Symbol	Size	+	-
A	4.10	-0.15	0.15
A1	2.50	-0.05	0.05
B	1.49	-0.05	0.05
B1	0.40	-0.05	0.05
C	0.40	-0.05	0.05
C1	0.50	-0.05	0.05
D	1.70	-0.05	0.05
D1	4.50	-0.05	0.05
E	1.50	-0.05	0.05
E1	3.00	-0.05	0.05
L	1.02	-0.05	0.05
L1	0.60	-0.05	0.05

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